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FILE 'GBFULL' ENTERED AT 10:34:41 ON 15 JUL 2009 COPYRIGHT (C) 2009 Univentio

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FILE 'RDISCLOSURE' ENTERED AT 10:34:41 ON 15 JUL 2009 COPYRIGHT (C) 2009 Kenneth Mason Publications Ltd.

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CA INDEXING COPYRIGHT (C) 2009 AMERICAN CHEMICAL SOCIETY (ACS)

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L5 ANSWER 1 OF 2 PCTFULL COPYRIGHT 2009 Univentio on STN

AN 2005056642 PCTFULL ED 20050628 EW 200525

TIEN RESHAPABLE SHAPE-MEMORY RESIN EXCELLING IN
SHAPE RECOVERY CAPABILITY AND SHAPED ITEM OF THE RESIN HAVING BEEN
CROSSLINKED

TIFR RESINE A MEMOIRE DE FORME REFACONNABLE PRESENTANT UNE CAPACITE DE

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       SHIMURA, Midori, c/o NEC Corporation, 7-1, Shiba 5-chome, Minato-ku,
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       Tokyo 1088001, JP [JP, JP];
       INOUE, Kazuhiko, c/o NEC Corporation, 7-1, Shiba 5-chome, Minato-ku,
       Tokyo 1088001, JP [JP, JP];
       IJI, Masatoshi, c/o NEC Corporation, 7-1, Shiba 5-chome, Minato-ku,
       Tokyo 1088001, JP [JP, JP]
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       NEC CORPORATION, 7-1, Shiba 5-chome, Minato-ku, Tokyo 1088001, JP [JP,
       JP], for all designates States except US;
       SHIMURA, Midori, c/o NEC Corporation, 7-1, Shiba 5-chome, Minato-ku,
       Tokyo 1088001, JP [JP, JP], for US only;
       INOUE, Kazuhiko, c/o NEC Corporation, 7-1, Shiba 5-chome, Minato-ku,
       Tokyo 1088001, JP [JP, JP], for US only;
       IJI, Masatoshi, c/o NEC Corporation, 7-1, Shiba 5-chome, Minato-ku,
       Tokyo 1088001, JP [JP, JP], for US only
ΑG
       MIYAZAKI, Teruo, 8th Floor, 16th Kowa Bldg., 9-20, Akasaka 1-chome,
       Minato-ku, Tokyo 1070052, JP
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       2007:169785 USPATFULL
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       Shape-memory resin performing
       remoldability and excellent in shape recovering property, and molded
       product composed of the cross-linked resin
       Shimura, Midori, Tokyo, JAPAN
Inoue, Kazuhiko, Tokyo, JAPAN
IN
       Iji, Masatoshi, Tokyo, JAPAN
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       US 20070148465
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      INCLM: 428/411.100
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TM

343-0807, JP

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       PROCESS AND USE THEREOF, AND PROCESS FOR PRODUCTION OF POLYBUTYLENE
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       PROCEDE DE FABRICATION, SES UTILISATIONS, ET PROCEDE DE PRODUCTION DE
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       Kagawa, Seiji, 304, 252-1, Akayama-cho 1-chome, Koshigaya-shi, Saitama
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KAWAGA, Seiji, 202, 252-1, Akayama-cho 1-chome, Koshigaya-shi, Saitama

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Kagawa, Seiji, 202, 252-1, Akayama-cho 1-chome, Koshigaya-shi, Saitama
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       Kagawa, Seiji, 202, 252-1, Akayama-cho 1-chome, Koshigaya-shi, Saitama
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       MOLDED OBJECT OF THERMOPLASTIC RESIN AND COMPOSITION.
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       HIROSE, Toshiyuki, c/o Mitsui Chemicals, Inc., 1-2, Waki 6-chome,
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       Waki-cho, Kuga-gun, Yamaguchi 740-0061, JP;
       MAENO, Masao, c/o Mitsui Chemicals, Inc., 1-2, Waki 6-chome, Waki-cho,
       Kuga-gun, Yamaguchi 740-0061, JP
       Mitsui Chemicals, Inc., 2-5, Kasumigaseki 3-chome, Chiyoda-ku, Tokyo
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ΙN
       6-chome, Waki-cho, Kuga-gun, Yamaguchi 740-0061, JP;
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       SHAPE MEMORY POLYAMIDE AND METHOD OF PRODUCING SHAPE MEMORY POLYAMIDE
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       KIM, Chang Woo, 1004-805, Hyosung Apartment Anyang-9dong, Anyang-si
TN
       Gyeonggi-do 430-019, KR
       HYOSUNG CORPORATION, 450, Kongduk-dong Mapo-gu Seoul 121-120, KR;
PA
       KIM, Chang Woo, 1004-805, Hyosung Apartment Anyang-9dong, Anyang-si
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                     AE AG AL AM AT AU AZ BA BB BG BR BW BY BZ CA CH CN CO CR
                     CU CZ DE DK DM DZ EC EE EG ES FI GB GD GE GH GM HR HU ID
                     IL IN IS JP KE KG KP KR KZ LC LK LR LS LT LU LV MA MD MG
                     MK MN MW MX MZ NA NI NO NZ OM PG PH PL PT RO RU SC SD SE
                     SG SK SL SY TJ TM TN TR TT TZ UA UG US UZ VC VN YU ZA ZM
                     ZW
       W-U:
                     AE AL AM AT AZ BG BR BY BZ CN CO CR CZ DE DK EC EE EG ES
                     FI GE HU JP KE KG KP KR KZ LS MD MX MZ NI PH PL PT RU SK
                     SL TJ TR TT UA UG UZ YU
       RW (ARIPO):
                     BW GH GM KE LS MW MZ NA SD SL SZ TZ UG ZM ZW
       RW (EAPO):
                     AM AZ BY KG KZ MD RU TJ TM
                     AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HU IE IS IT LT
       RW (EPO):
                     LU MC NL PL PT RO SE SI SK TR
       RW (OAPI):
                     BF BJ CF CG CI CM GA GN GQ GW ML MR NE SN TD TG
       RW-U (OAPI): BF BJ CF CG CI CM GA GN GQ GW ML MR NE SN TD TG
PRAI
       JP 2003-2003-415258
                               20031212
                            A 20041210
       WO 2004-JP18490
ΑТ
ICM
       C08G085-00
ICS
       C08F008-00; C08G063-91; C08G064-42; C08L101-16
     ANSWER 6 OF 13 USPATFULL on STN
L4
       2007:169785 USPATFULL
ΑN
ΤI
       Shape-memory resin performing
       remoldability and excellent in shape recovering property, and molded
       product composed of the cross-linked resin
       Shimura, Midori, Tokyo, JAPAN
Inoue, Kazuhiko, Tokyo, JAPAN
ΙN
       Iji, Masatoshi, Tokyo, JAPAN
PΙ
       US 20070148465
                           A1 20070628
ΑI
       US 2004-582675
                           A1 20041210 (10)
       WO 2004-JP18490
                               20041210
                               20060612 PCT 371 date
PRAI
      JP 2003-415258
                               20031212
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DТ
       Utility
FS
       APPLICATION
LN.CNT 1487
       INCLM: 428/411.100
INCL
       INCLS: 521/040.000
NCL
       NCLM:
             428/411.100
       NCLS:
             521/040.000
              B32B0009-04 [I,A]; C08J0011-04 [I,A]; C08J0011-00 [I,C*]
IC
       IPCI
              B32B0009-04 [I,C]; B32B0009-04 [I,A]; C08G0063-00 [I,C*];
       TPCR
              C08G0063-08 [I,A]; C08G0063-91 [I,A]; C08J0011-00 [I,C];
              C08J0011-04 [I,A]; C08K0005-00 [I,C*]; C08K0005-12 [I,A]
CAS INDEXING IS AVAILABLE FOR THIS PATENT.
     ANSWER 7 OF 13 USPATFULL on STN
T.4
       2006:67187 USPATFULL
ΑN
ΤI
       Method and apparatus for producing polybutylene terephthalate film, and
       shape-memory polybutylene terephthalate laminate film
       Kagawa, Seiji, Saitama-ken, JAPAN
ΙN
PΤ
       US 20060057405
                           A1 20060316
                           A1
ΑI
       US 2003-528366
                               20030922 (10)
       WO 2003-JP12103
                               20030922
                               20050318 PCT 371 date
       JP 2002-275939
                               20020920
PRAI
       JP 2003-1533
                               20030107
       JP 2003-1534
                               20030107
       JP 2003-122785
                               20030425
       Utility
DT
FS
       APPLICATION
LN.CNT 2531
       INCLM: 428/458.000
INCL
       INCLS: 428/480.000; 428/481.000
       NCLM: 428/458.000
NCL
       NCLS: 428/480.000; 428/481.000
IC
       IPCI
              B32B0027-36 [I,A]; B32B0027-10 [I,A]; B32B0015-08 [I,A]
       IPCR
              B32B0027-36 [I,A]; B29C0035-00 [N,C*]; B29C0035-16 [N,A];
              B29C0047-00 [N,C*]; B29C0047-00 [N,A]; B29C0047-06 [I,C*];
              B29C0047-06 [I,A]; B29C0047-88 [I,C*]; B29C0047-88 [I,A];
              B29C0047-90 [N,C*]; B29C0047-90 [N,A]; B29C0047-92 [I,C*];
              B29C0047-92 [I,A]; B29C0055-28 [I,C*]; B29C0055-28 [I,A];
              B29C0061-06 [I,C*]; B29C0061-06 [I,A]; B32B0015-08 [I,C];
              B32B0015-08 [I,A]; B32B0027-06 [I,C*]; B32B0027-06 [I,A];
              B32B0027-10 [I,C]; B32B0027-10 [I,A]; B32B0027-36 [I,C];
              B32B0037-12 [N,C*]; B32B0037-12 [N,A]; B32B0037-14 [I,C*];
              B32B0037-15 [N,A]; B32B0037-20 [I,A]; B65D0077-10 [I,C*];
              B65D0077-20 [I,A]
CAS INDEXING IS AVAILABLE FOR THIS PATENT.
     ANSWER 8 OF 13 USPATFULL on STN
L4
ΑN
       2006:60375 USPATFULL
       Shape-memory polybutylene terephthalate film, production process and use
ΤI
       thereof, and process for production of polybutylene terephthalate film
       Kagawa, Seiji, Saitama-ken, JAPAN
ΤN
PΙ
       US 20060051540
                           A1 20060309
ΑI
                               20030922 (10)
       US 2003-528371
                           A1
       WO 2003-JP12102
                               20030922
                               20050318 PCT 371 date
PRAI
       JP 2002-275939
                               20020920
       JP 2003-1533
                               20030107
       JP 2003-1534
                               20030107
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DТ
       Utility
FS
       APPLICATION
LN.CNT 2652
       INCLM: 428/035.700
INCL
       INCLS: 428/043.000
NCL
       NCLM:
              428/035.700
       NCLS:
              428/043.000
IC
       IPCI
              B32B0027-08 [I,A]
              B32B0027-08 [I,A]; B29C0035-00 [N,C*]; B29C0035-16 [N,A];
       TPCR
              B29C0047-00 [N,C*]; B29C0047-00 [N,A]; B29C0047-06 [I,C*];
              B29C0047-06 [I,A]; B29C0047-88 [I,C*]; B29C0047-88 [I,A];
              B29C0047-90 [N,C*]; B29C0047-90 [N,A]; B29C0047-92 [I,C*];
              B29C0047-92 [I,A]; B29C0055-28 [I,C*]; B29C0055-28 [I,A];
              B29C0061-06 [I,C*]; B29C0061-06 [I,A]; B32B0027-08 [I,C];
              B32B0037-12 [N,C*]; B32B0037-12 [N,A]; B32B0037-14 [I,C*];
              B32B0037-15 [N,A]; B32B0037-20 [I,A]
CAS INDEXING IS AVAILABLE FOR THIS PATENT.
T.4
     ANSWER 9 OF 13 USPATFULL on STN
       2002:343774 USPATFULL
ΑN
ΤI
       Molded object of thermoplastic resin and composition
ΙN
       Hirose, Toshiyuki, Yamaguchi-ken, JAPAN
       Maeno, Masao, Yamaguchi-ken, JAPAN
       US 20020197499
                           A1 20021226
PΙ
       US 6709761
                            В2
                                20040323
ΑI
       US 2001-19221
                            A1 20011228 (10)
       WO 2001-JP3709
                                20010727
       JP 2000-131245
                                20000428
PRAT
       JP 2000-131700
                                20000428
DT
       Utility
       APPLICATION
FS
LN.CNT 1291
INCL
       INCLM: 428/517.000
       INCLS: 428/910.000; 428/520.000
NCL
       NCLM:
              428/517.000
       NCLS:
              428/520.000; 428/522.000; 428/910.000; 525/191.000; 525/216.000;
              525/221.000; 525/240.000; 525/241.000
IC
       [7]
       ICM
              B32B027-08
       IPCI
              B32B0027-08 [ICM, 7]
       IPCI-2 B32B0027-32 [ICM, 7]; C08J0005-18 [ICS, 7]; C08L0023-26 [ICS, 7];
              C08L0023-00 [ICS, 7, C*]
              C08L0023-00 [I,C*]; C08L0023-08 [I,A]; C08L0065-00 [I,C*];
       TPCR
              C08L0065-00 [I,A]
CAS INDEXING IS AVAILABLE FOR THIS PATENT.
     ANSWER 10 OF 13 USPATFULL on STN
T.4
       2001:146875 USPATFULL
ΑN
TΙ
       Image-forming system
       Suzuki, Minoru, Tochigi, Japan
Orita, Hiroshi, Saitama, Japan
ΤN
       Saito, Hiroyuki, Saitama, Japan
       Suzuki, Katsuyoshi, Tokyo, Japan
       Furusawa, Koichi, Tokyo, Japan
PA
       Asahi Kogaku Kogyo Kabushiki Kaisha, Tokyo, Japan (non-U.S. corporation)
PΙ
       US 6283649
                            B1 20010904
ΑI
       US 2000-599850
                                20000623 (9)
       Continuation of Ser. No. US 1999-263260, filed on 5 Mar 1999, now
RLT
       patented, Pat. No. US 6106173
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JP 1998-73454
                              19980306
PRAT
       Utility
DT
       GRANTED
FS
LN.CNT 611
INCL
       INCLM: 400/120.010
       INCLS: 400/120.020; 400/124.080; 400/124.090; 400/149.000; 347/171.000;
              347/172.000
NCL
              400/120.010
       NCLS:
             347/171.000; 347/172.000; 400/120.020; 400/124.080; 400/124.090;
              400/149.000
IC
       [7]
       ICM
              B41J002-32
       IPCI
              B41J0002-32 [ICM, 7]
              B41J0002-32 [I,A]; B41J0002-32 [I,C*]
       400/120.01; 400/120.05; 400/120.06; 400/120.07; 400/120.08; 400/120.09;
EXF
       400/120.1; 400/120.11; 400/120.12; 400/120.13; 400/120.14; 400/120.15;
       400/124.08; 400/124.09; 400/124.11; 400/124.12; 400/124.13; 400/124.14;
       400/124.15; 400/149; 400/120.02-120.04; 347/171; 347/172; 347/180;
       347/181; 347/182; 347/188; 347/189; 347/190; 347/191; 347/192
L4
    ANSWER 11 OF 13 USPATFULL on STN
       2001:54821 USPATFULL
ΑN
TΙ
       Temperature control apparatus
       Orita, Hiroshi, Saitama, Japan
ΤN
       Suzuki, Minoru, Tochigi, Japan
       Saito, Hiroyuki, Saitama, Japan
       Suzuki, Katsuyoshi, Tokyo, Japan
       Furusawa, Koichi, Tokyo, Japan
PΑ
       Asahi Kogaku Kogyo Kabushiki Kaisha, Tokyo, Japan (non-U.S. corporation)
PΙ
       US 6217239
                          B1 20010417
       US 1999-275422
                               19990324 (9)
ΑI
       JP 1998-96590
PRAI
                               19980325
DT
       Utility
FS
       Granted
LN.CNT 689
INCL
       INCLM: 400/120.010
       INCLS: 400/120.020; 400/120.140; 347/171.000; 347/172.000; 347/191.000;
              347/194.000
NCL
       NCLM:
              400/120.010
       NCLS:
             347/171.000; 347/172.000; 347/191.000; 347/194.000; 400/120.020;
              400/120.140
IC
       [7]
       TCM
              B41J002-315
       IPCI
              B41J0002-315 [ICM, 7]
       IPCR
              B41J0002-32 [I,A]; B41J0002-32 [I,C*]; B41J0002-365 [I,A];
              B41J0002-365 [I,C*]
       400/120.01; 400/120.02; 400/120.14; 347/194; 347/191; 347/171; 347/172;
EXF
       347/5; 347/17
     ANSWER 12 OF 13 USPATFULL on STN
L4
ΑN
       2000:108684 USPATFULL
ΤI
       Image-forming system including a plurality of thermal heads and an
       image-forming sheet with a plurality of types of micro-capsules
       Suzuki, Minoru, Tochigi, Japan
TN
       Orita, Hiroshi, Saitama, Japan
       Saito, Hiroyuki, Saitama, Japan
       Suzuki, Katsuyoshi, Tokyo, Japan
       Furusawa, Koichi, Tokyo, Japan
PA
       Asahi Kogaku Kogyo Kabushiki Kaisha, Tokyo, Japan (non-U.S. corporation)
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ductruong

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US 6106173
PΤ
                               20000822
                               19990305 (9)
       US 1999-263260
AΙ
       JP 1998-73454
PRAI
                               19980306
       Utility
DT
FS
       Granted
LN.CNT 616
INCL
       INCLM: 400/120.020
       INCLS: 400/241.200; 400/149.000; 400/082.000; 347/172.000; 347/173.000
NCL
             400/120.020
       NCLS: 347/172.000; 347/173.000; 400/082.000; 400/149.000; 400/241.200
IC
       [7]
              B41J002-32
       ICM
       ICS
              B41J003-54
       IPCI
              B41J0002-32 [ICM, 7]; B41J0003-54 [ICS, 7]
              B41J0002-32 [I,A]; B41J0002-32 [I,C*]
       IPCR
       347/212; 347/172; 347/173; 400/241.2; 400/120.01; 400/120.02;
EXF
       400/120.04; 400/124.08; 400/124.09; 400/124.1; 400/149; 400/82;
       428/321.5
     ANSWER 13 OF 13 USPAT2 on STN
L4
       2002:343774 USPAT2
ΑN
TΙ
       Molded object of thermoplastic resin and composition
ΙN
       Hirose, Toshiyuki, Yamaguchi-ken, JAPAN
       Maeno, Masao, Yamaguchi-ken, JAPAN
       Mitsui Chemicals, Inc., Tokyo, JAPAN (non-U.S. corporation)
PA
PΙ
       US 6709761
                           B2 20040323
       WO 2001083612
                               20011108
                               20011228 (10)
       US 2001-19221
ΑТ
       WO 2001-JP3709
                               20010427
       JP 2000-131245
                               20000428
PRAI
       JP 2000-131700
                               20000428
DT
       Utility
FS
       GRANTED
LN.CNT 1274
INCL
       INCLM: 428/517.000
       INCLS: 428/520.000; 428/522.000; 428/910.000; 525/191.000; 525/216.000;
              525/221.000; 525/240.000; 525/241.000
NCL
       NCLM:
              428/517.000
              428/520.000; 428/522.000; 428/910.000; 525/191.000; 525/216.000;
       NCLS:
              525/221.000; 525/240.000; 525/241.000
IC
       [7]
       ICM
              B32B027-32
       TCS
              C08J005-18; C08L023-26
              B32B0027-08 [ICM, 7]
       IPCI-2 B32B0027-32 [ICM, 7]; C08J0005-18 [ICS, 7]; C08L0023-26 [ICS, 7];
              C08L0023-00 [ICS, 7, C*]
              C08L0023-00 [I,C*]; C08L0023-08 [I,A]; C08L0065-00 [I,C*];
              C08L0065-00 [I,A]
EXF
       428/517; 428/520; 428/522; 428/910; 525/191; 525/216; 525/221; 525/240;
       525/241
CAS INDEXING IS AVAILABLE FOR THIS PATENT.
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